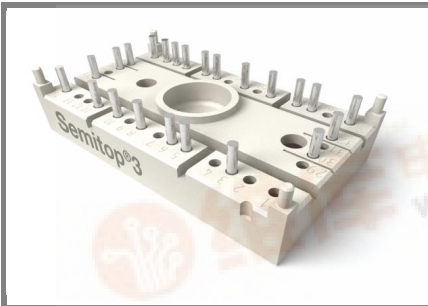


SK 9 DGD 065 ET



SEMITOP[®] 3

3-phase bridge rectifier + 3-phase bridge inverter

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Preliminary Data

Features

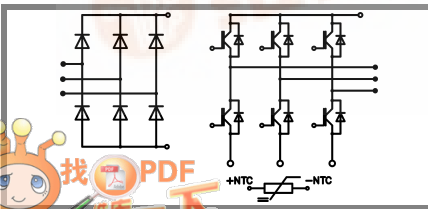
- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminum oxide ceramic (DCB)
- Ultrafast NPT technology IGBT
- CAL Technology FWD
- Integrated NTC temperature sensor

Typical Applications

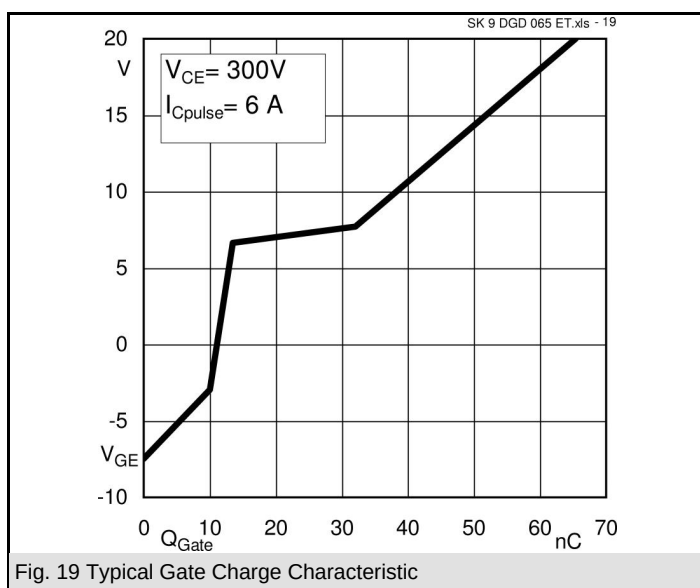
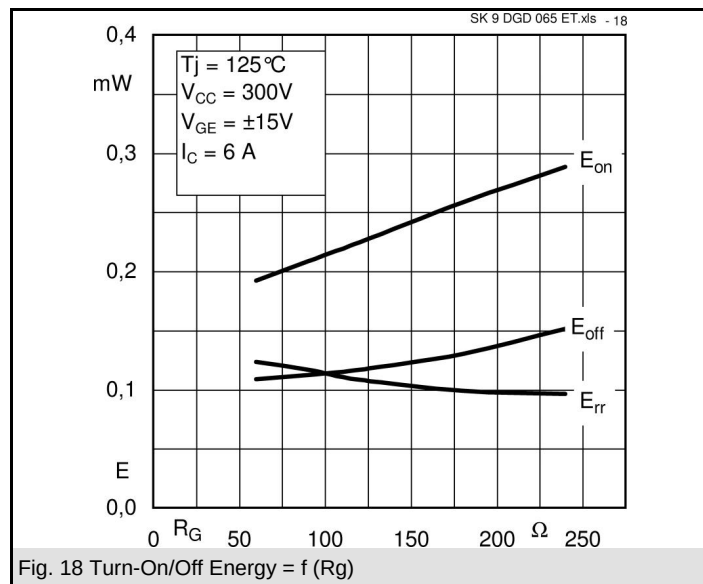
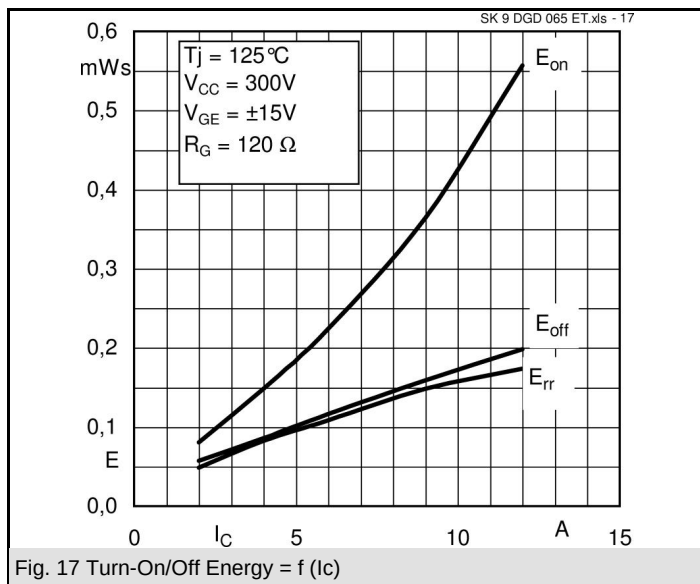
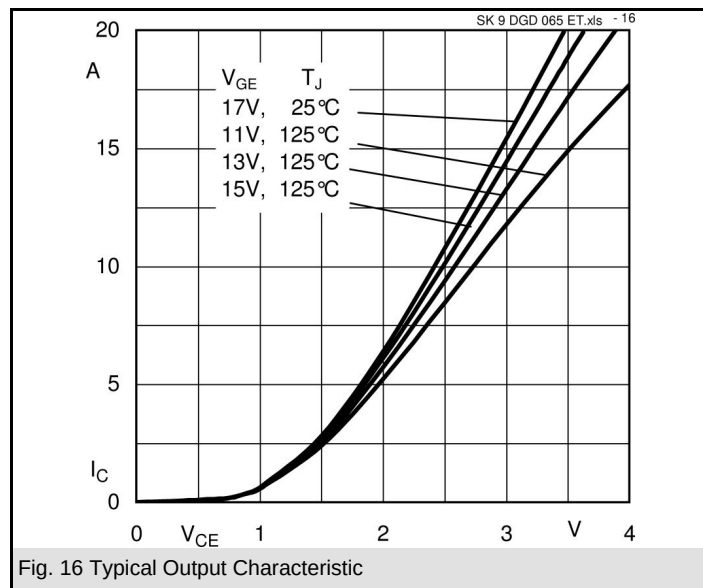
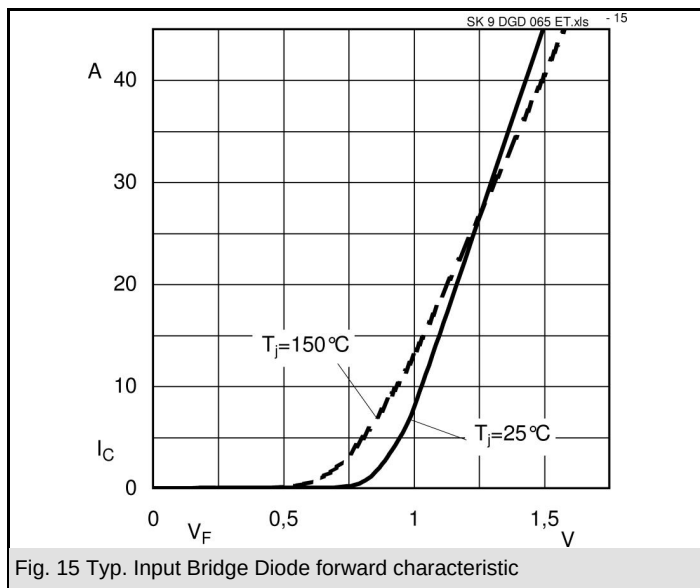
- Inverter

Absolute Maximum Ratings		$T_s = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT - Inverter			
V_{CES}	$T_s = 25\ (80)^\circ\text{C}$ $I_{CRM} = 2 \times I_{Cnom}$, $t_p = 1\ \text{ms}$	600	V
I_C		12 (8)	A
I_{CRM}		12	A
V_{GES}		± 20	V
T_j		-40 ... +150	$^\circ\text{C}$
Diode - Inverter			
I_F	$T_s = 25\ (80)^\circ\text{C}$	20 (13)	A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$, $t_p = 1\ \text{ms}$	16	A
T_j		-40 ... +150	$^\circ\text{C}$
Rectifier			
V_{RRM}	$T_s = 80^\circ\text{C}$ $t_p = 10\ \text{ms}$, $\sin 180^\circ$, $T_j = 25^\circ\text{C}$ $t_p = 10\ \text{ms}$, $\sin 180^\circ$, $T_j = 25^\circ\text{C}$	800	V
I_F		25	A
I_{FSM} / I_{TSM}		220	A
I_t^2		240	A^2s
T_j		-40 ... +150	$^\circ\text{C}$
T_{sol}	Terminals, 10s	260	$^\circ\text{C}$
T_{stg}		-40 ... +125	$^\circ\text{C}$
V_{isol}	AC, 1 min. / 1s	2500 / 3000	V

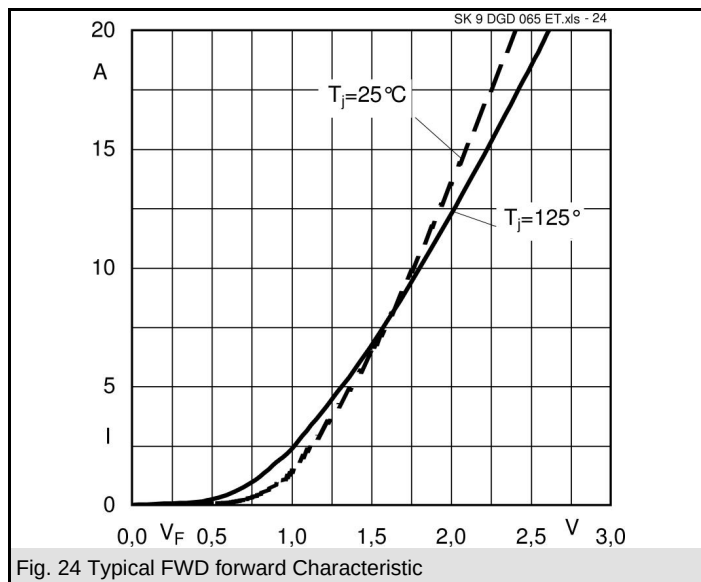
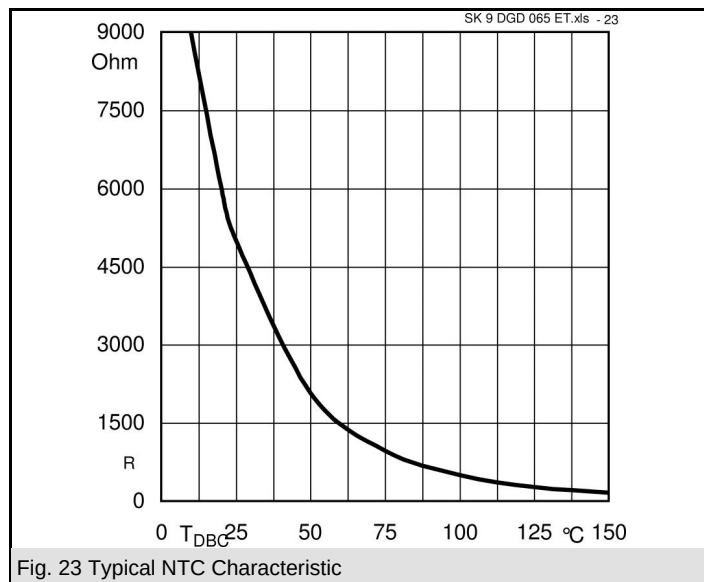
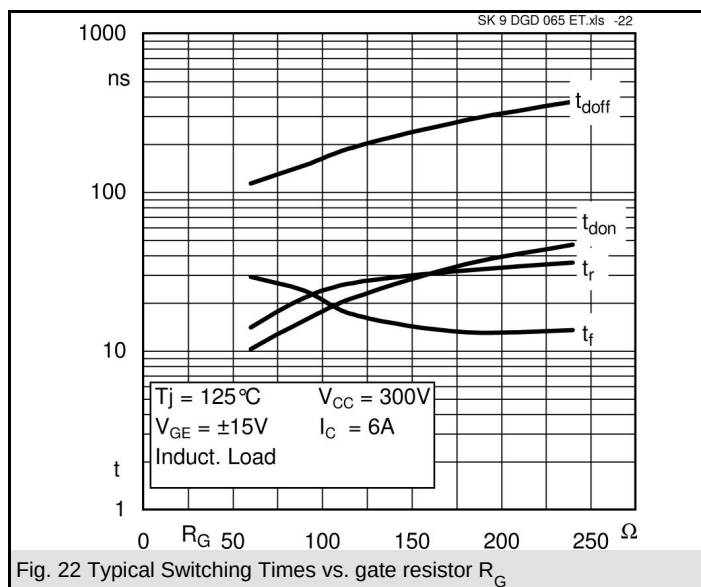
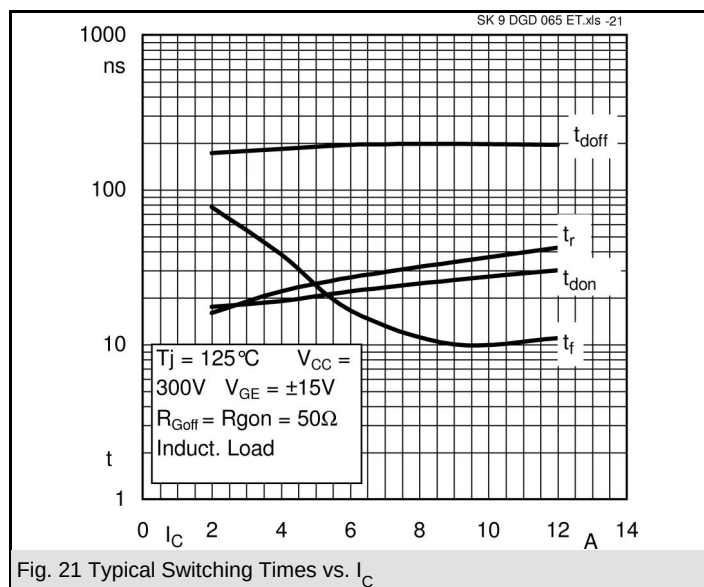
Characteristics		$T_s = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT - Inverter					
V_{CEsat}	$I_C = 6\ \text{A}$, $T_j = 25\ (125)^\circ\text{C}$		2 (2,2)		V
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 0,5\ \text{mA}$	3	4	5	V
$V_{CE(TO)}$	$T_j = 25^\circ\text{C}\ (125)^\circ\text{C}$		1,2 (1,1)		V
r_T	$T_j = 25^\circ\text{C}\ (125)^\circ\text{C}$		133 (183)		m Ω
C_{ies}	$V_{CE} = V_{GE} = 0\ \text{V}$, $f = 1\ \text{MHz}$		0,35		nF
C_{oes}	$V_{CE} = V_{GE} = 0\ \text{V}$, $f = 1\ \text{MHz}$		0,4		nF
C_{res}	$V_{CE} = V_{GE} = 0\ \text{V}$, $f = 1\ \text{MHz}$		0,25		nF
$R_{th(j-s)}$	per IGBT			2,6	K/W
$t_{d(on)}$	under following conditions		20		ns
t_r	$V_{CC} = 300\ \text{V}$, $V_{GE} = \pm 15\ \text{V}$		25		ns
$t_{d(off)}$	$I_C = 6\ \text{A}$, $T_j = 125^\circ\text{C}$		145		ns
t_f	$R_{Gon} = R_{Goff} = 120\ \Omega$		25		ns
E_{on}	inductive load		0,22		mJ
E_{off}			0,12		mJ
Diode - Inverter					
$V_F = V_{EC}$	$I_F = 8\ \text{A}$, $T_j = 25\ (125)^\circ\text{C}$		1,35		V
$V_{(TO)}$	$T_j = 25^\circ\text{C}\ (125)^\circ\text{C}$		(0,8)		V
r_T	$T_j = 25^\circ\text{C}\ (125)^\circ\text{C}$		(44)		m Ω
$R_{th(j-s)}$	per diode			2,7	K/W
I_{RRM}	under following conditions		4,2		A
Q_{rr}	$I_F = 8\ \text{A}$, $V_R = 300\ \text{V}$		0,65		μC
E_{rr}	$V_{GE} = 0\ \text{V}$, $T_j = 125^\circ\text{C}$ $di_F/dt = -120\ \text{A}/\mu\text{s}$				mJ
Diode rectifier					
V_F	$I_F = 20\ \text{A}$, $T_j = 25^\circ\text{C}$		1,1		V
$V_{(TO)}$	$T_j = 150^\circ\text{C}$		0,85		V
r_T	$T_j = 150^\circ\text{C}$		15		m Ω
$R_{th(j-s)}$	per diode			2,15	K/W
Temperatur sensor					
R_{ts}	5 %, $T_r = 25\ (100)^\circ\text{C}$		5000(493)		Ω
Mechanical data					
w			31		g
M_s	Mounting torque	2,3		2,5	Nm



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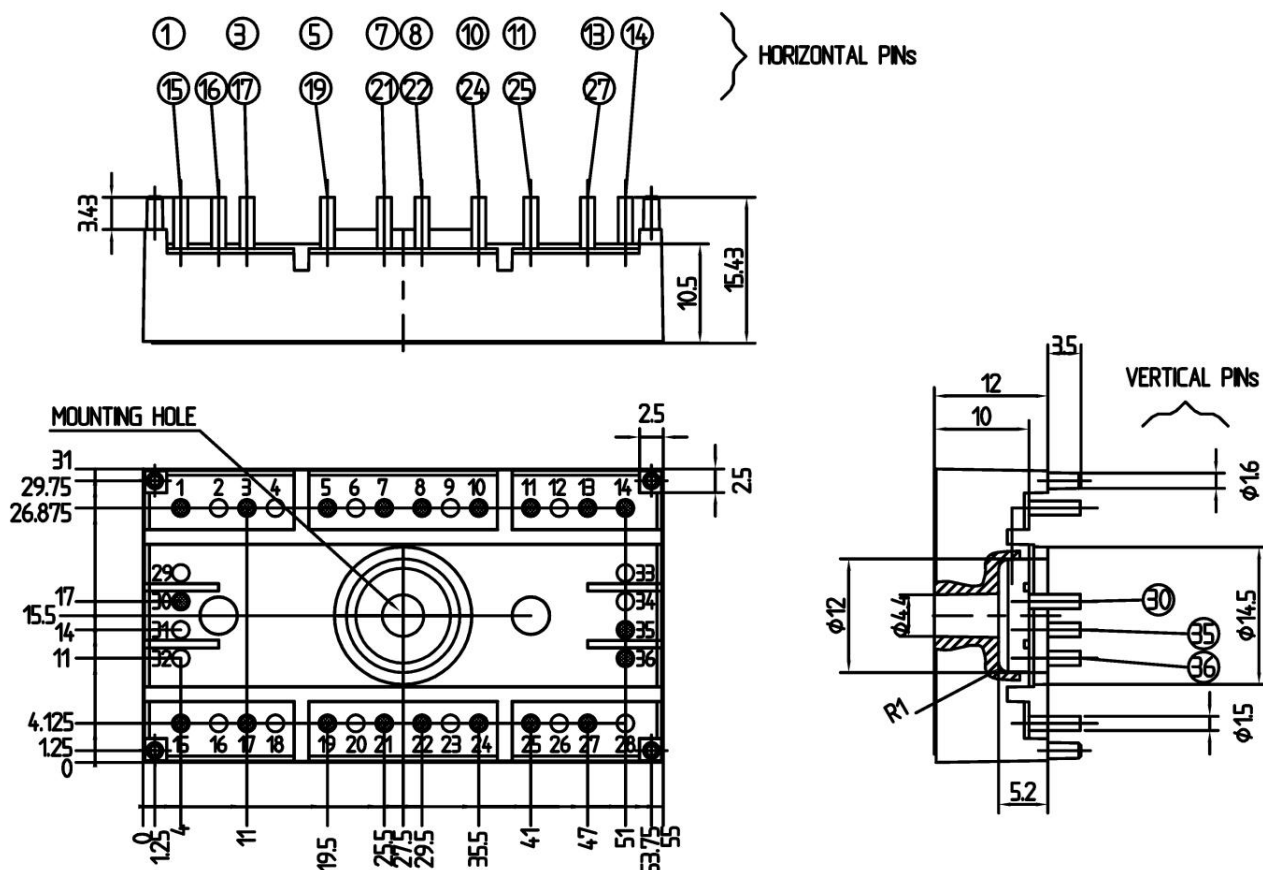


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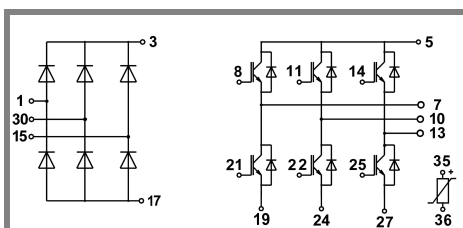


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Dimensions in mm



Case T60 (Suggested hole diameter, in the PCB, for solder pins and plastic mounting pins: 2mm)



Case T60 DGD - ET

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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